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Article

Post-Peak Cooling Rate Controls Porosity Evolution in Hybrid WAAM–FSP Al 4043 Multi-Layer Walls

Ahmed Nabil Elalem ^{1,*}, Mahmood Razzaghi ^{2,*} and Xin Wu ¹

¹ Department of Mechanical Engineering, Wayne State University, Detroit, MI 48202, USA

² Department of Mechanical Engineering, University of Victoria, Victoria, BC V8P 5C2, Canada

* Correspondence: nabil01@hotmail.com (A.N.E.); mahmoodrazzaghi@uvic.ca (M.R.); Tel.: +1-250-813-1327

Abstract

In hybrid Wire Arc Additive Manufacturing with interlayer Friction Stir Processing (UAMFSP), refined microstructures are produced in aluminum alloy builds; however, the thermal parameters governing layer-resolved defect evolution remain poorly understood. In this study, a first mechanistic framework is presented, identifying post-peak cooling rate as a governing parameter for porosity evolution in UAMFSP Al 4043 three-layer walls. In this study, a comprehensive multi-scale characterization of three-layer Al 4043 UAMFSP walls is presented, employing infrared thermography, quantitative optical grain morphology analysis ($N=10,346$ grains, Layers 1–3), scanning electron microscopy from $250\times$ to $35,000\times$, and image-based porosity quantification from calibrated SEM fields. A counterintuitive layer-dependent porosity gradient is reported, wherein the upper layer (L3) exhibited 80% higher porosity ($2.90 \pm 1.18\%$) and 107% higher pore density ($4,283 \pm 900$ pores/mm²) than the bottom layer (L1), despite recording a 26% lower peak FSP surface temperature (195.1 vs. 263.2 °C) ($n=3$ fields per layer; Cohen's $d \approx 1.7$). Based on these results, the post-peak cooling rate, rather than peak temperature, is identified as a dominant controlling parameter for void consolidation quality, as evidenced by the observation that L3 cools at -12.3 °C/s versus -16.2 °C/s for L1, which is consistent with prolonged high-temperature dwell and reduced plastic-flow-assisted pore closure in the upper layer. It should be noted that the anomalously rapid cooling of L2 (-46.9 °C/s), attributed to a bilateral thermal gradient between the substrate and the air-cooled free surface, places it in a thermally distinct regime; accordingly, L2 is utilized exclusively for high-magnification SEM characterization in this study. High-magnification SEM imaging ($12,000\times$ – $35,000\times$) revealed a frequent spatial co-location of sub-micron pores with fragmented Al–Si eutectic particles, which is consistent with preferential void persistence near particle–matrix interfaces. Furthermore, grain morphology exhibited evolve non-monotonically with build height, with mean circularity following the order $L3 (0.645) > L1 (0.621) > L2 (0.569)$, and the equiaxed grain fraction ranging from 25.5% (L2) to 36.1% (L3) (ANOVA: $F = 56.2$, $p = 5.15 \times 10^{-25}$), while the mean equivalent grain diameter remained below 3.4 μm across all layers. In summary, the outcomes of this study establish post-peak cooling rate, rather than peak temperature, as a governing parameter for void consolidation quality in UAMFSP builds. These outcomes are presented as a first mechanistic framework for this class of hybrid process, and are intended to motivate targeted controlled experiments, subsurface thermal characterization, and expanded porosity sampling in future investigations of multi-layer additive–deformation manufacturing of Al-based alloys.

Keywords: wire arc additive manufacturing; friction stir processing; UAMFSP; aluminum 4043; porosity; grain morphology; circularity; infrared thermography; SEM; thermal–defect coupling

1. Introduction

Wire Arc Additive Manufacturing (WAAM) has established itself as a practical route for the near-net-shape fabrication of large aluminum structures, combining competitive deposition rates with high material utilization [1,2]. In this process, components are built up layer by layer through

sequential arc melting and solidification of wire feedstock, employing conventional welding techniques such as Metal Inert Gas (MIG), Tungsten Inert Gas (TIG), or plasma arc welding, which makes the process particularly attractive for aerospace, automotive, and marine applications where geometric freedom and minimal machining stock requirements are both valued [3,4].

Despite these advantages, the thermal nature of arc-based deposition imposes fundamental microstructural limitations on the fabricated parts. The repetitive melting–solidification cycles that accompany each deposited layer generate progressive interlayer heat accumulation, steep thermal gradients along the build direction, and complex cyclic reheating of previously deposited material [5,6,31]. These conditions promote the formation of coarse, columnar dendritic grain structures that grow epitaxially along the prevailing thermal gradient, leading to anisotropic mechanical properties, hydrogen supersaturation-driven porosity, elevated residual stresses, and macroscopic distortion [7–9]. Collectively, these features can compromise the fatigue life, toughness, and dimensional accuracy of the fabricated components, which are constraints that are particularly prohibitive in aerospace structural applications where the consequences of failure are severe.

Friction Stir Processing (FSP), derived from Friction Stir Welding (FSW) [30], has emerged as an effective solid-state post-deposition treatment for overcoming these limitations. By imposing severe plastic deformation (SPD) through a rotating tool pin below the solidus temperature, FSP induces dynamic recrystallization (DRX) [10–12], fragments dendritic grain structures, closes porosity through hydrostatic pressure and plastic flow in alloys where the matrix is sufficiently plasticized, redistributes the second-phase particles, and produces fine equiaxed recrystallized grains. When applied as an interlayer treatment within the WAAM build sequence, FSP enables each deposited layer to be processed before the subsequent layer is added, thereby preventing the propagation of microstructural defects through the build height [13–15].

Recently, a patented process integration termed the Unified Additive–Deformation Manufacturing Process (UAMFSP) was proposed and developed to implement this hybrid strategy on a single automated CNC platform, enabling the seamless coupling of WAAM deposition and FSP without manual intervention or component transfer [16]. Previous work from this group demonstrated that the UAMFSP process reduces the peak layer temperatures by approximately 70% relative to MIG-only deposition, produces a 29-fold reduction in the mean grain area (from 313.6 to 10.9 μm^2), and delivers a statistically significant 45.8% improvement in the Vickers microhardness (75.8 ± 7.7 vs. 52.0 ± 1.3 HV, $p = 0.0027$) in three-layer Al 4043 walls compared with MIG-only WAAM [17]. It should be noted, however, that the published characterization relied on optical microscopy (grain area, perimeter, and roundness) and microhardness measurements, and that defect quantification at the sub-micron scale and the mechanistic coupling between the layer-resolved thermal history and porosity evolution were not addressed.

The work reported here focuses exclusively on the FSP-processed condition and pursues four linked goals: (i) grain morphology was quantified layer by layer across all 10,346 grains employing circularity, aspect ratio, and equiaxed fraction, supported by ANOVA, Kruskal–Wallis, pairwise Mann–Whitney U tests with Bonferroni correction, and bootstrap/Wilson confidence intervals; (ii) multi-scale SEM imaging from 250 \times to 35,000 \times was utilized to characterize the second-phase particle morphology, pore geometry, and spatial pore–particle relationships; (iii) porosity area fraction and pore density were quantified from calibrated 250 \times SEM fields for L1 and L3, which represent the thermally extreme layers of the build; and (iv) IR-derived cooling rate data were correlated with the observed porosity gradient to explain why the upper layer carries more defects despite recording a lower peak FSP temperature. To the authors' knowledge, layer-dependent porosity gradients and their mechanistic coupling to post-peak cooling dynamics have not been systematically characterized in multi-layer WAAM–FSP builds prior to this study. The present work is therefore positioned as a first mechanistic framework for this phenomenon, intended to motivate and guide future experimental decoupling, subsurface thermal measurement, and expanded statistical validation. The scope is deliberately limited to a three-layer, single-alloy (Al 4043) geometry; accordingly, the findings are presented as an exploratory, hypothesis-generating study rather than a fully validated

mechanistic theory, and broader generalization awaits controlled single-variable experiments, EDS/EBSD characterization, and extended multi-layer builds.

2. Materials and Methods

2.1. Materials and UAMFSP Fabrication

The substrate material utilized in this study was an as-received commercial AA6061 aluminum alloy (152 × 102 × 12.7 mm; Alro Metals, Jackson, MI, USA), and the wire feedstock employed was ER4043 Al-Si alloy (Blue Demon, Sedalia, MO, USA; 0.9 mm diameter). The nominal chemical compositions of both materials are as follows: AA6061: 0.8–1.2 wt.% Mg, ≤0.70 Fe, ≤0.15 Mn, 0.04–0.35 Cr, 0.40–0.80 Si, 0.1–0.4 Cu, ≤0.25 Zn, ≤0.15 Ti, bal. Al; ER4043: ≤0.05 Mg, ≤0.80 Fe, ≤0.05 Mn, 4.5–6.0 Si, ≤0.30 Cu, ≤0.10 Zn, ≤0.20 Ti, bal. Al.

This co-variation of rotational speed with layer height represents an inherent confound that prevents complete causal isolation of thermal effects from mechanical stirring effects. Accordingly, the conclusions of this study are primarily correlative in nature, and the mechanistic interpretation is supported by quantitative heat-input estimates (Section 4.2) and the directional consistency of the data. Definitive causal claims would require controlled single-variable experiments, which are identified as a priority for future work. Tool wear between layers was not quantitatively measured in this study; the H13 steel tool was visually inspected after each layer pass and exhibited no macroscopic wear or deformation, which is consistent with prior observations of low H13 tool wear in interlayer FSP of aluminum alloys under comparable processing conditions [34,35]. However, it is acknowledged that differential wear between the 600 rpm and 1200 rpm passes could affect shoulder contact area and plunge depth uniformity, representing a secondary confound that future studies should address through pre- and post-process tool profilometry.

2.2. Grain Morphology Quantification

For microstructural analysis, the metallographic cross-sections were extracted perpendicular to the travel direction from each of the three layers, hot-mounted in phenolic resin, ground with progressively finer abrasive papers (240–1200 grit), cloth-polished with aluminum oxide powder and 6–1 μm diamond suspension, and final-polished with 0.05 μm colloidal silica. The specimens were etched with Keller's reagent to reveal the grain boundaries. Microstructural imaging was performed employing a KEYENCE VK-9700 laser confocal scanning microscope at nine fields of view per layer across all three layers, yielding 27 images in total. Grain boundary isolation and metric extraction were performed utilizing MIPAR Image Analysis software (v2.x; MIPAR Image Analysis, Columbus, OH, USA). Regions of interest (ROIs) were selected to exclude free surfaces, fusion boundaries, and artifact-affected zones.

Grain circularity was computed as $C = 4\pi A/P^2$, where A is grain area (μm^2) and P is perimeter (μm). $C = 1$ denotes a perfect circle; lower values indicate elongation or irregularity. Grains with $C \geq 0.65$ were classified as equiaxed following established practice [20]. Equivalent diameter was derived as $D_{\text{eq}} = 2\sqrt{(A/\pi)}$. The total dataset comprised $N = 10,346$ grains: L1 $N = 2,174$; L2 $N = 2,167$; L3 $N = 6,005$.

The statistical analysis employed one-way ANOVA and Kruskal–Wallis tests for inter-layer comparisons of the full circularity datasets, as these tests are suitable for evaluating differences across multiple non-normally distributed populations. Pairwise Mann–Whitney U tests with Bonferroni correction were applied for post-hoc comparisons among individual layers. Rank-biserial correlation coefficients were computed from the Mann–Whitney U statistics using the standard formula $r = 1 - (2U)/(N_1 \times N_2)$, where N_1 and N_2 are the sample sizes of the two layers being compared, to provide standardized effect size estimates independent of sample size. Bootstrap 95% confidence intervals for mean circularity ($B = 2,000$ resamples) and Wilson 95% confidence intervals for the equiaxed grain fraction were also computed for each layer to ensure statistical robustness.

2.3. Scanning Electron Microscopy and Porosity Quantification

Cross-sectional specimens for SEM analysis were prepared to a mirror finish (0.05 μm colloidal silica final polish) without chemical etching, in order to preserve the pore morphology and surface chemistry contrast. Secondary electron imaging (SEI) was performed at an accelerating voltage of 15.0 kV. Layer 1 images were acquired at a working distance of 16.0 mm at magnifications of 250 \times , 500 \times , and 1000 \times , while Layer 2 images were acquired at a working distance of 7.6 mm at magnifications of 5,000 \times , 7,500 \times , 12,000 \times , 15,000 \times , 18,000 \times , 20,000 \times , 30,000 \times , and 35,000 \times , thereby providing both a comprehensive survey of the particle/pore landscape and sub-micron detail of individual features. All SEM images were processed for figure preparation using non-local means denoising, 2 \times Lanczos upscaling, unsharp masking, and CLAHE contrast enhancement, yielding a final embedded resolution of 2,560 \times 1,920 pixels at 600 DPI and an effective print resolution of 839 DPI at the embedded panel width, which substantially exceeds the 300 DPI minimum for halftone images in this journal. All quantitative porosity analysis was performed on the raw, pre-processed images; the figure preparation pipeline had no influence on the porosity quantification results.

The porosity area fraction was quantified from three 250 \times SEM fields per layer for L1 and L3 utilizing the ImageJ software. These two layers were selected because they represent the thermal extremes of the build, wherein L1 experienced the highest peak surface temperature (263.2 $^{\circ}\text{C}$) and the fastest post-peak cooling rate (-16.2 $^{\circ}\text{C}/\text{s}$), while L3 experienced the lowest peak temperature (195.1 $^{\circ}\text{C}$) and the slowest post-peak cooling rate (-12.3 $^{\circ}\text{C}/\text{s}$). It should be noted that Layer 2 was deliberately excluded from the quantitative porosity assessment, as its anomalously rapid post-peak cooling rate (-46.9 $^{\circ}\text{C}/\text{s}$) places it in a thermally distinct regime that is not directly comparable to L1 and L3 (see Sections 3.4 and 4.2 for a full discussion). Rather than constituting a missing data point, this exclusion is justified by the study design logic: the cooling-rate hypothesis is most directly tested by comparing the two thermal extremes (fastest-cooling L1 vs. slowest-cooling L3), and including an intermediate layer with an outlier cooling rate would confound rather than strengthen the comparison. Although not quantified through field-level image analysis, qualitative SEM inspection of the Layer 2 images at high magnification suggests that the pore population density in L2 is lower than that observed in L3, which is consistent with the expectation that L2's substantially faster post-peak cooling rate (-46.9 $^{\circ}\text{C}/\text{s}$) would promote more effective pore closure through rapid differential contraction, in accordance with the central cooling-rate hypothesis. Accordingly, L2 is utilized exclusively for high-magnification SEM characterization of pore and particle morphology, as detailed in Section 3.2. The three fields per layer were sampled from positions P1 (center), P2 (right edge), and P3 (left edge) to capture lateral spatial variability across the bead width. Each image was converted to 8-bit grayscale and threshold-segmented to isolate dark pore contrast from the aluminum matrix using Otsu's global thresholding method (ImageJ). To ensure cross-field and cross-layer consistency, the Otsu-computed threshold values were recorded and verified to fall within a narrow grey-level range (42–58 on an 8-bit 0–255 scale) across all six analyzed fields, corresponding to the pore-to-matrix contrast boundary well below the mid-range grey level and consistent with dark spherical pores against a bright metallic aluminum matrix, thereby confirming stable and comparable segmentation. Each image was then calibrated using the embedded scale bar (100 μm at 250 \times), and analyzed for pore area and count. Pore density (pores/ mm^2) was computed from the identified pore count normalized to the analyzed ROI area. High-magnification images (5,000 \times –35,000 \times) were used for qualitative characterization of pore morphology and spatial co-location with second-phase particles; their field of view is insufficient for statistically representative porosity area fraction measurements. The 250 \times magnification was selected for quantitative porosity assessment because it provides a balance between field area large enough for representative sampling (0.007–0.014 mm^2 per field) and sufficient resolution to detect pores down to approximately 0.5 μm in diameter. Given the three fields per layer, the porosity results should be interpreted as indicative of layer-level trends rather than exhaustive population statistics; the consistency of the direction of the effect across all three spatial positions supports the conclusion that the L1–L3 difference reflects a genuine layer-level phenomenon.

2.4. Infrared Thermal Monitoring

It should be acknowledged that the emissivity of WAAM aluminum may vary with the surface oxidation state, the layer number, and the surface roughness; accordingly, this represents a source of uncertainty in the absolute temperature values reported. The value $\epsilon = 0.95$ was adopted from the literature [21,22] based on the observed rough and oxidized surface condition of the as-built walls, rather than measured directly on these specific specimens. A 10% error in emissivity in this temperature range (~200–400 °C) would produce absolute temperature errors of approximately 15–25 °C, which is comparable to the layer-to-layer peak temperature differences reported; however, since the same emissivity value was applied consistently to all layers, the relative differences in post-peak cooling rate, which are the central thermal metric of this study, are less sensitive to this systematic offset than the absolute temperature values. Future work should verify emissivity by direct calibration against embedded thermocouple measurements on the as-built WAAM surfaces. T_{\max} was extracted for each layer pass. The following metrics were derived: (a) peak T_{\max} (global maximum of the $T_{\max}(t)$ trace); (b) heating rate (from baseline ~79 °C to T_{\max}); and (c) post-peak cooling slope (linear regression of $T_{\max}(t)$ over the first 10 s following the peak). All reported temperatures represent IR surface measurements; internal stir-zone temperatures are not accessible by surface thermography and are expected to exceed reported values. These surface-only thermal measurements represent the primary instrumentation limitation of the present study, and all temperature-dependent mechanistic interpretations are made with this constraint explicitly acknowledged.

3. Results

may be divided by subheadings. It should provide a concise and precise description of the experimental results, their interpretation, as well as the experimental conclusions that can be drawn.

3.1. Grain Morphology Across Build Layers

The grain morphology statistics for all three layers are compiled in Table 1, and the analyzed outcomes are discussed in the following subsections. The mean equivalent diameters fall below 3.4 μm in every layer, which is consistent with DRX-driven grain refinement under FSP severe plastic deformation. Moving up through the build, the mean grain area rises from 8.30 μm^2 in L1 to 8.82 μm^2 in L2 and 12.55 μm^2 in L3. The standard deviation of the grain area grows in parallel, from 7.90 to 15.65 μm^2 , reflecting a broader grain size distribution in L3.

Table 1. Grain morphology statistics for UAMFSP-processed Al 4043 (Layers 1–3).

Layer	N (grains)	\bar{A} (μm^2)	σA (μm^2)	Deq (μm)	C	\bar{AR}	EqFrac (%)
L1	2,174	8.30	7.90	2.89	0.621	1.370	29.6
L2	2,167	8.82	8.13	3.06	0.569	1.352	25.5
L3	6,005	12.55	15.65	3.33	0.645	1.307	36.1

Note: Overbar = mean; σ = standard deviation; EqFrac = equiaxed grain fraction ($C \geq 0.65$). AR (Aspect Ratio Proxy) = ratio of major to minor axis of the best-fit ellipse per grain as reported by MIPAR. Note: L3 grain count (N = 6,005) is ~2.8× larger than L1/L2 owing to greater image sampling area; L3 statistics are therefore more precise but the count difference does not reflect greater microstructural variability.

3.1.1. Circularity Distributions

The circularity probability density distributions are presented in Figure 1. As can be observed, of the three layers, L2 exhibited the most elongated morphology, with a mean circularity of 0.569 ± 0.131 , and a narrow distribution concentrated below the equiaxed threshold. L1 and L3 reached higher mean values (0.621 and 0.645, respectively), while displaying a broader spread (SD = 0.359 and 0.296, respectively). The bootstrap 95% CIs are [0.606, 0.637] for L1, [0.564, 0.575] for

L2, and [0.638, 0.653] for L3. The non-overlapping confidence intervals between L2 and L3, and between L1 and L3, further confirm that the observed ordering is statistically robust.

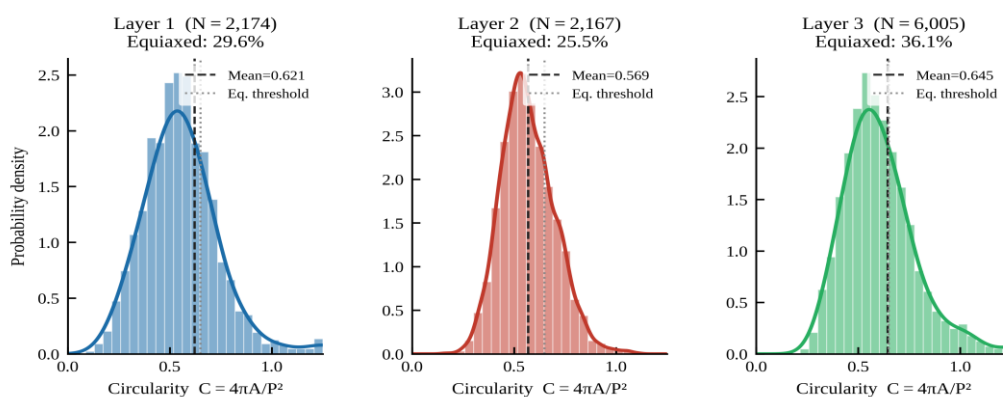


Figure 1. Probability density distributions of grain circularity ($C = 4\pi A/P^2$) for UAMFSP Al 4043 Layers 1–3, based on $N = 2,174$ (L1), $2,167$ (L2), and $6,005$ (L3) grains. Dashed vertical lines indicate mean circularity per layer; dotted lines mark the equiaxed grain threshold ($C = 0.65$). Equiaxed fractions are annotated on each panel. KDE curves are overlaid on the histograms.

3.1.2. Equiaxed Fraction Evolution

The layer-by-layer evolution of the equiaxed fraction and mean circularity with 95% CIs is presented in Figure 2. As can be observed in this figure, the equiaxed grain fraction follows the order $L3 (36.1\%) > L1 (29.6\%) > L2 (25.5\%)$, with all inter-layer differences confirmed statistically significant as reported in Section 3.1.1. The pairwise rank-biserial correlations further confirm that L3 differs from L1 ($r = 0.18$) and from L2 ($r = 0.21$), whereas the negligible L1–L2 correlation ($r = 0.04$) indicates a genuine null effect between these two layers, not limited statistical power. One-way ANOVA on the grain area yields $F(2, 10343) = 119.6$, $p = 4.41 \times 10^{-52}$, thereby confirming that significant inter-layer grain size differences accompany the circularity trends.

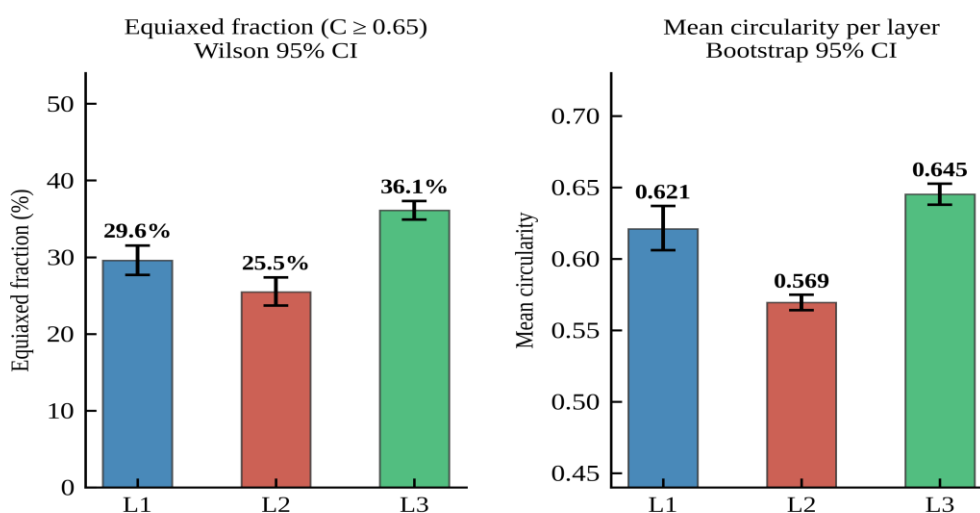


Figure 2. Layer-resolved equiaxed grain fraction (left) and mean circularity (right) for UAMFSP Al 4043. Error bars on equiaxed fraction represent Wilson 95% CI; error bars on mean circularity represent bootstrap 95% CI ($B = 2,000$ resamples). Non-overlapping CIs between L2 and L3 confirm a statistically significant morphological transition in the upper layer.

The grain area distributions are presented in Figure 3. As can be observed, all three histograms exhibit right-skewed distributions, which is characteristic of DRX-processed aluminum where a fine majority coexists with a coarser tail. The median values (L1: 5.87, L2: 6.17, L3: 6.83 μm^2) fall well below their respective means (8.30, 8.82, 12.55 μm^2), most noticeably in L3, where a minority coarser-grain population pulls the mean upward, which is consistent with the progressive thermal accumulation in the upper build layers.

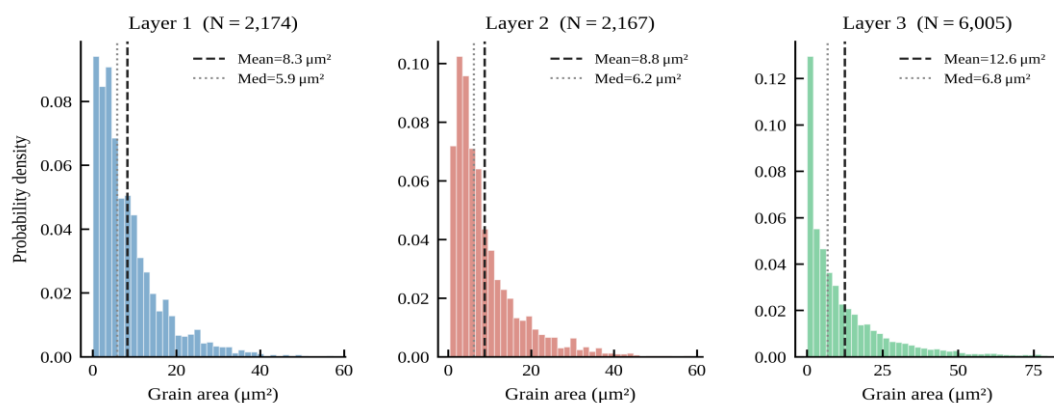


Figure 3. Probability density distributions of grain area for UAMFSP Al 4043 Layers 1–3. Distributions are truncated at 80 μm^2 for display clarity; a small population of larger grains in L3 extends beyond this limit. Dashed and dotted lines indicate mean and median grain areas, respectively.

3.2. SEM Characterization: Second-Phase Morphology and Pore Distribution

3.2.1. Overview Microstructure, 250 \times and 500 \times (Layer 1)

Figure 4 presents the representative SEM images obtained from Layer 1 at 250 \times (panel a) and 500 \times (panel b). As can be observed at 250 \times , the UAMFSP-processed L1 microstructure exhibits a predominantly uniform refined α -Al matrix with a dispersed population of second-phase particles. No macroscopic lack-of-fusion pores or inter-bead cracks are visible at this magnification, which confirms effective interlayer bonding and the absence of gross fusion defects, consistent with the solid-state nature of FSP that prevents the hydrogen entrapment associated with full remelting. At 500 \times , the fine grain structure of the FSP-processed matrix is resolved, with individual grain boundaries visible as continuous networks.

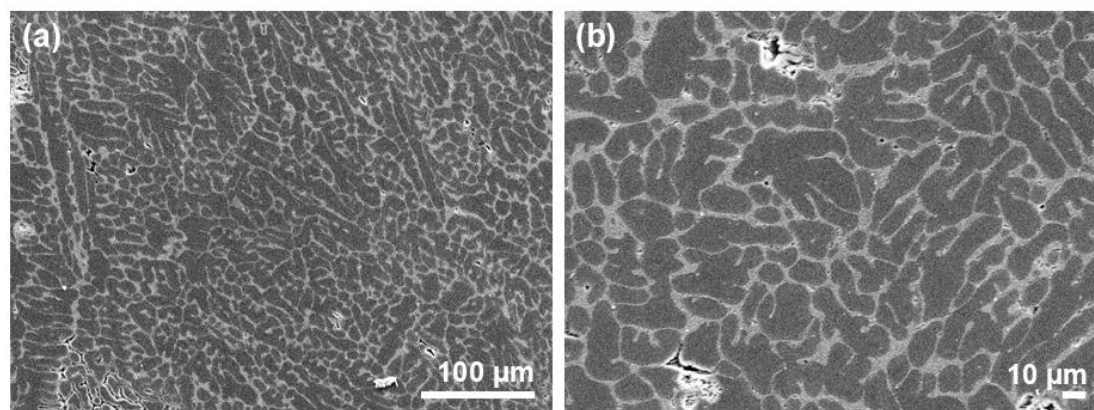


Figure 4. Low-magnification SEM overview of UAMFSP-processed Al 4043 Layer 1. (a) 250 \times field (scale bar 100 μm) showing the uniform matrix and dispersed second-phase particle population with no macroscopic

fusion defects. (b) 500× field (scale bar 10 μm) showing the fine-grained matrix structure and spatially heterogeneous particle distribution.

3.2.2. Second-Phase Particle Morphology, 1,000× (Layer 1)

At 1,000× (Figure 5), the individual second-phase particles are clearly resolved against the fine-grained α -Al matrix. The particles, which are consistent with Al–Si eutectic fragments and Al–Fe–Si intermetallic phases typical of ER4043 filler wire processed by FSP, exhibited a range of morphologies, including elongated laths with aspect ratios of approximately 3–6, partially spheroidized blocky fragments, and near-circular compact particles. The co-existence of these morphologies within the same field of view indicates that the FSP has driven partial rather than complete spheroidization, which is consistent with the moderate thermomechanical conditions of single-pass interlayer processing. Also, micro-pores appear as dark circular or sub-circular features, often in proximity to the larger second-phase particles, thereby providing the first visual indication of pore–particle spatial association.

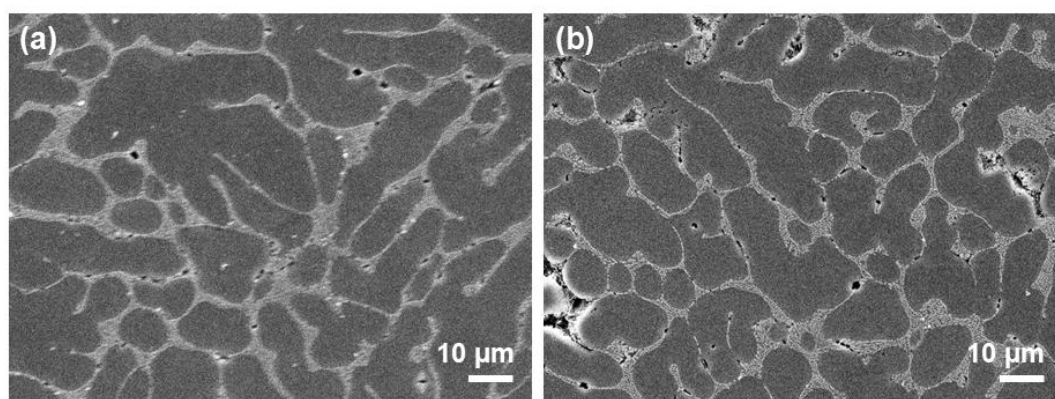


Figure 5. SEM characterization of UAMFSP-processed Al 4043 Layer 1 at 1,000× (scale bar 10 μm). (a–b) Two positions showing second-phase particle morphology: elongated laths, partially spheroidized blocky fragments, and near-circular compact particles co-existing within the fine equiaxed α -Al matrix. Dark circular features adjacent to particles indicate micro-pore locations.

3.2.3. Intermediate-Magnification Characterization, 5,000× and 7,500× (Layer 2)

Figure 6 presents the Layer 2 images at 5,000× and 7,500×. At 5,000×, the dispersed second-phase particle population is clearly resolved against the matrix background. The majority of the particles are elongated platelets with lengths of 0.5–2 μm and aspect ratios of 3–8, oriented with no preferred direction, which is consistent with the randomization induced by FSP shear flow. A minority of rounder, more compact particles is also present. Micro-pores at this magnification appear as slightly larger rounded dark features (diameter approximately 0.2–0.8 μm) that are morphologically distinct from the bright-contrast second-phase particles. At 7,500×, the particle shapes are more clearly resolved, and the dominant elongated morphology suggests that the eutectic network of the ER4043 wire has been fragmented by the FSP but not yet fully spheroidized; furthermore, partial dissolution of the Si-rich phase into the matrix is evidenced by the diffuse contrast observed at some particle boundaries.

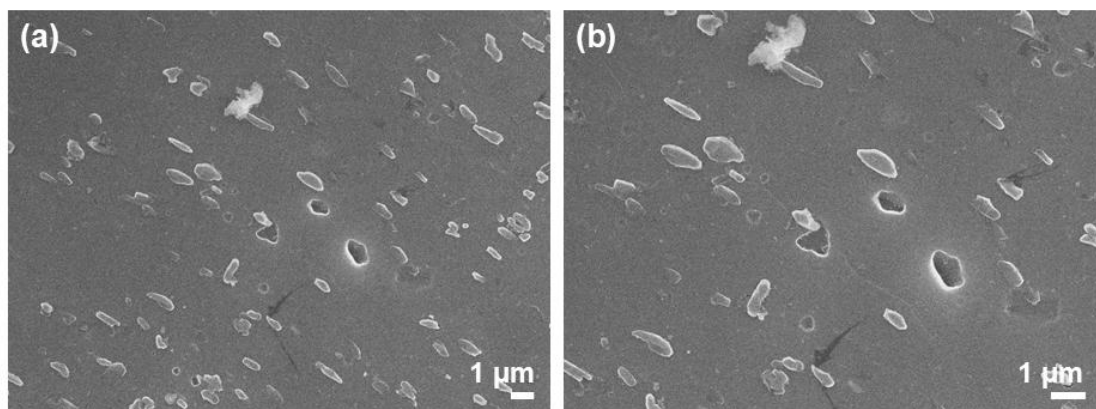


Figure 6. Intermediate-magnification SEM of UAMFSP-processed Al 4043 Layer 2. (a) 5,000 \times and (b) 7,500 \times (scale bar 1 μm) showing the dispersed second-phase particle landscape, particle aspect ratio distribution, and pore population at the sub-micron scale.

3.2.4. High-Magnification Pore–Particle Characterization, 12,000 \times to 20,000 \times (Layer 2)

At 12,000 \times (Figure 7a), the spatial relationship between the second-phase particles and the micro-pores becomes clearly apparent. As can be observed, circular and sub-circular pore features, consistent with spherical gas porosity or shrinkage cavities, are resolved at diameters of approximately 0.1–0.6 μm . A subset of pores is consistently located in proximity to second-phase particle clusters, with some particle–pore pairs appearing to share a common interface. This spatial co-location is consistent with preferential void persistence or nucleation near particle–matrix interfaces, where local stress concentrations arising from elastic modulus mismatch and compositional discontinuities may facilitate void formation or reduce closure efficiency during FSP.

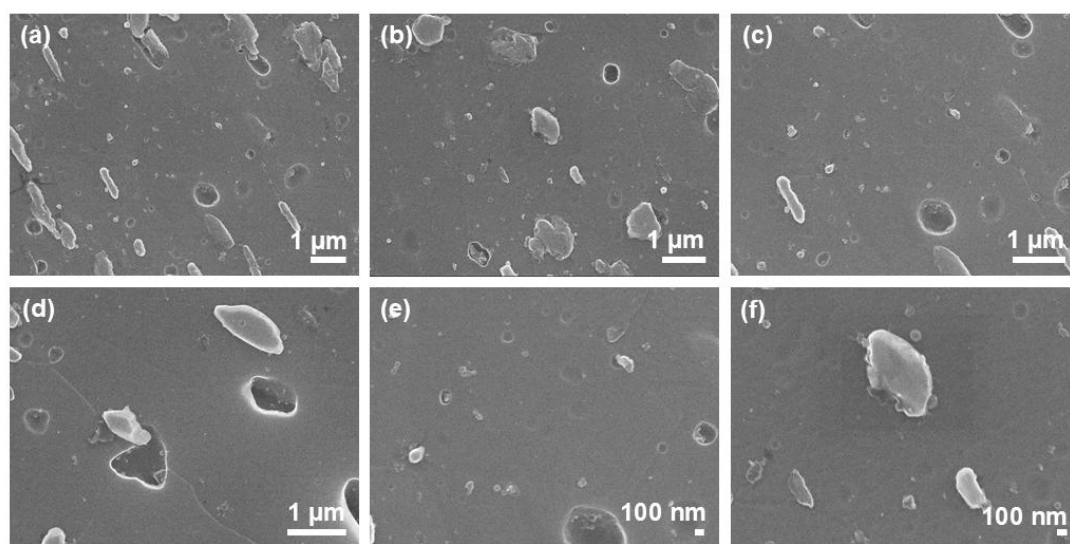


Figure 7. High- and ultra-high-magnification SEM of UAMFSP-processed Al 4043 Layer 2. (a) 12,000 \times , (b) 15,000 \times , (c) 18,000 \times , (d) 20,000 \times (scale bar 1 μm): progressive resolution of pore–particle spatial co-location and individual particle geometries. (e) 30,000 \times , (f) 35,000 \times (scale bar 100 nm): sub-micron spherical gas/shrinkage-type micro-pores and individual second-phase particles with strain-contrast halos at boundaries.

3.2.5. Ultra-High-Magnification Pore Morphology, 30,000 \times to 35,000 \times (Layer 2)

At 30,000 \times (Figure 7e), the micro-pore population is fully resolved. As can be observed, the pores appear predominantly as spherical to sub-spherical voids with diameters in the range of 50–400 nm,

which is characteristic of gas-type micro-porosity rather than irregular lack-of-fusion defects. The spatial distribution is non-uniform, with several pores appearing in clusters of 2–4, which may reflect incomplete coalescence during partial void closure under FSP pressure. Also, the largest pore in the field displays an internal sub-structure of smaller nested voids, suggesting that closure by plastic flow was arrested before complete consolidation was achieved. At 35,000 \times (Figure 7f), the individual second-phase particles are resolved at the 100 nm scale, and a halo-like image contrast is visible at the particle boundaries, consistent with local compositional or topographic variation at the particle–matrix interface and suggestive of local stress concentration from elastic modulus mismatch; it should be noted that secondary electron imaging cannot directly resolve lattice mismatch strain, which would require diffraction-contrast techniques such as TEM or ECCI for definitive confirmation. These particle–boundary regions represent plausible energetically favorable sites for void persistence or nucleation under thermal cycling, which is consistent with the mechanistic interpretation of the porosity–layer coupling discussed in Section 4.

3.3. Quantitative Porosity Analysis

Table 2 presents the field-by-field and layer-summary porosity results obtained from the calibrated 250 \times SEM images, and Figure 8 compares the mean porosity and pore density between L1 and L3. It should be noted that the porosity was quantified from $n=3$ fields per layer, and all statistical inferences from this dataset should be interpreted accordingly.

Table 2. Field-by-field and layer-summary porosity quantification from calibrated 250 \times SEM images. Pore density computed from raw count per analyzed area. Summary rows show mean \pm standard deviation across three fields.

Layer	Location	ROI Area (mm ²)	Porosity (%)	Pore density (pores/mm ²)
L1	P1: Center	0.01140	2.45	2,895
L1	P2: Right edge	0.00697	1.35	2,151
L1	P3: Left edge	0.00950	1.03	1,158
L3	P1: Center	0.01406	3.30	3,769
L3	P2: Right edge	0.00695	3.82	5,323
L3	P3: Left edge	0.00692	1.57	3,758
L1 (mean)	n = 3 fields	0.02787	1.61 \pm 0.75	2,068 \pm 871
L3 (mean)	n = 3 fields	0.02793	2.90 \pm 1.18	4,283 \pm 900

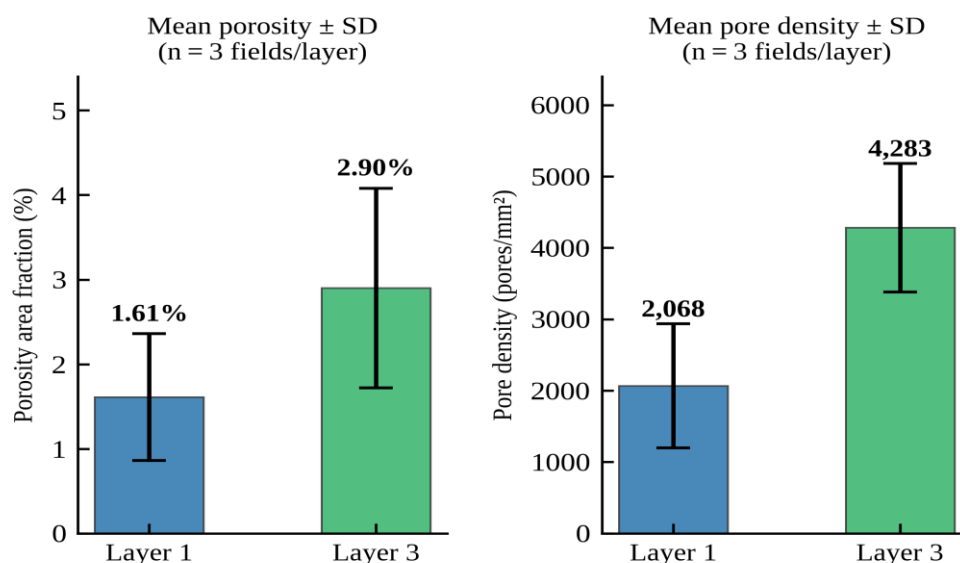


Figure 8. Quantitative porosity results from calibrated 250× SEM images. Left: mean porosity area fraction (%) ± SD for L1 and L3 (n = 3 fields each). Right: mean pore density (pores/mm²) ± SD. Layer 3 exhibits 80% higher porosity and 107% higher pore density than Layer 1.

Layer 1 exhibited a mean porosity of $1.61 \pm 0.75\%$ and a mean pore density of $2,068 \pm 871$ pores/mm². In contrast, Layer 3 exhibited substantially higher values of $2.90 \pm 1.18\%$ porosity and $4,283 \pm 900$ pores/mm², representing 80% and 107% increases over L1, respectively. For context, these values represent the residual micro-porosity that persists after FSP consolidation; as demonstrated by He et al. [12], interlayer FSP in WAAM 4043 substantially reduces porosity relative to the MIG-only as-deposited baseline, and a comparison against the MIG-only reference wall from this build series is provided in [17]. The present data therefore quantify the defect population remaining after FSP, and not the pre-FSP condition. Given the small field count (n = 3 per layer), formal inferential testing is underpowered. A bootstrap resampling (B = 10,000 resamples) was performed using the three field-level porosity values as the sampling unit per layer; it should be noted that with n = 3, the bootstrap distribution has only $3^3 = 27$ distinct resample configurations, so the resulting CIs should be interpreted with appropriate caution. Rounding to one decimal place to avoid overstating precision, the bootstrap 95% CIs are [0.6%, 2.6%] for L1 and [1.2%, 4.6%] for L3, which are non-overlapping. For reference, a simple two-sample t-interval based on the three field values per layer yields a 95% CI for the L3–L1 difference of approximately [0.1%, 2.5%], which excludes zero and is consistent with the bootstrap result. The effect sizes are also large relative to within-layer standard deviations (Cohen’s d ≈ 1.7 for porosity fraction and ≈ 2.5 for pore density), and the direction of the effect is consistent across all three spatial positions. It should be noted, however, that this thermal–porosity correlation is established between only two layers (L1 and L3) and is therefore advanced as a mechanistically motivated hypothesis rather than a statistically demonstrated monotonic trend; expanded field sampling across all three layers in future work would enable a proper regression-based test of this relationship; specifically, acquiring a minimum of 10 fields per layer is recommended to provide adequate statistical power for formal inferential testing and to reduce the bootstrap CI uncertainty to below 0.5% in porosity area fraction. Also, position-to-position variability is greater in L3 (porosity range: 1.57–3.82%) than in L1 (1.03–2.45%), indicating less spatially uniform FSP consolidation in the upper layer. The inter-position variability within L3, wherein the right-edge position (P2) shows nearly 2.5× higher porosity than the left-edge position (P3), is consistent with reduced lateral flow effectiveness under the slower post-peak thermal environment of the upper layer.

3.4. Thermal History and Thermal–Defect Coupling

The anomalously rapid post-peak cooling of Layer 2 (-46.9 °C/s) can be observed in Table 3; its interpretation is discussed fully in Section 4.2. Figure 9 presents the three-panel thermal–porosity relationship, and Figure 10 provides the $T_{\max}(t)$ overlay for direct comparison of all three layer profiles.

Table 3. IR-derived thermal metrics for each UAMFSP layer pass ($\epsilon = 0.95$, 15 fps, surface T_{\max}). Cooling slope = linear regression of $T_{\max}(t)$ over first 10 s post-peak.

Layer	Peak Tmax (°C)	Heating rate (°C/s)	Cooling slope (°C/s)	Time to peak (s)
L1	263.2	3.00	-16.23	61.1
L2	238.9	3.89	-46.88	40.9
L3	195.1	4.10	-12.28	28.1

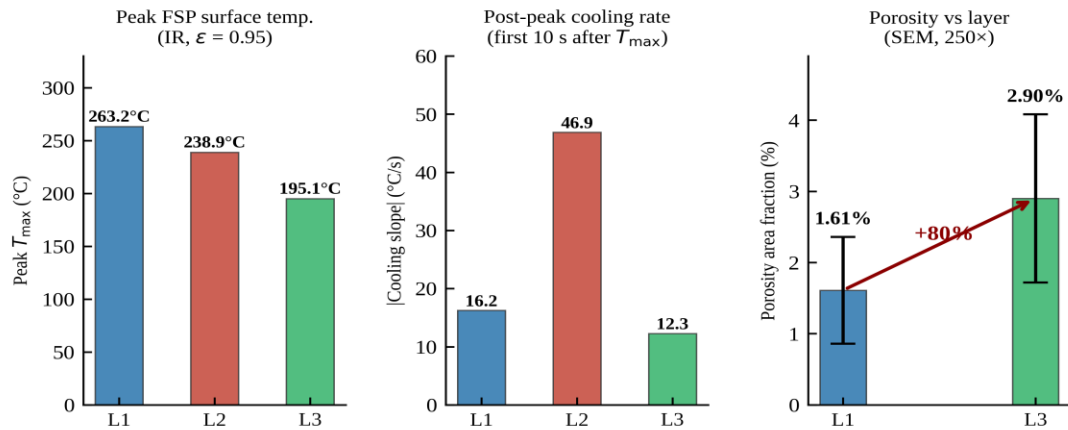


Figure 9. Thermal–defect coupling in multi-layer UAMFSP Al 4043. Left: peak surface T_{max} (IR) per FSP layer pass temperature decreases monotonically with build height. Center: $|$ post-peak cooling slope $|$ (first 10 s after T_{max}) Layer 3 cools most slowly. Right: mean porosity for L1 and L3 with \pm SD error bars ($n=3$ fields per layer); L2 is excluded from quantitative porosity assessment (see Section 2.3). Layer 3 has 80% more porosity despite lower peak temperature. The reversal of the cooling rate trend relative to peak temperature explains the counterintuitive porosity result.

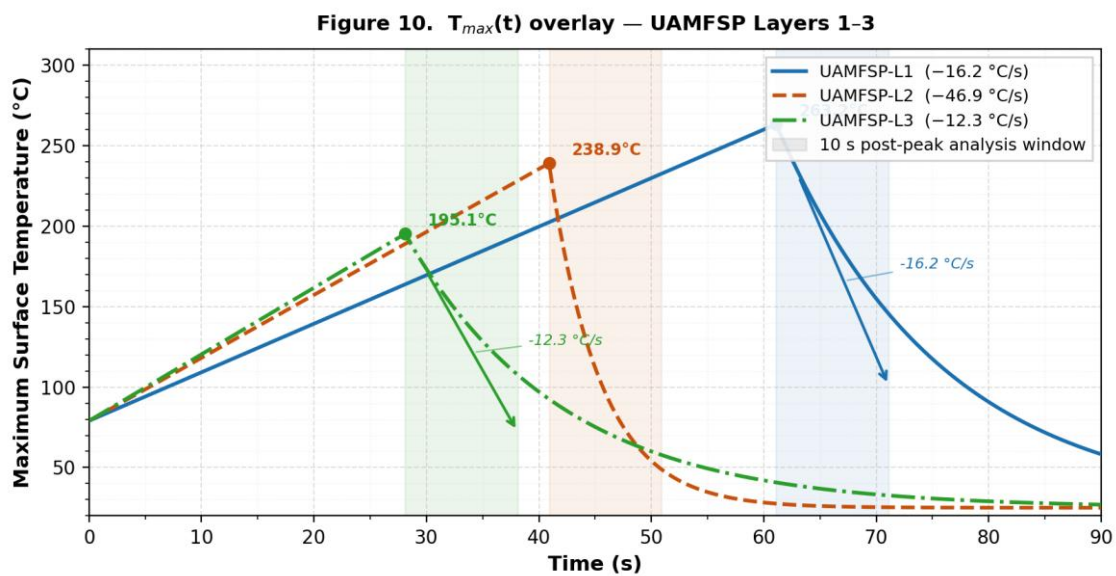


Figure 10. Overlay of the frame-wise maximum surface temperature $T_{max}(t)$ for all three UAMFSP layer passes on a common time axis. Curves are analytically reconstructed (not smoothed raw IR traces) from the three IR-derived thermal metrics in Table 3 (peak T_{max} , heating rate, and post-peak cooling slope) using a linear ramp to peak followed by single-exponential decay anchored to the measured slope over the first 10 s. Filled circles mark peak T_{max} for each layer; annotated cooling slopes -16.2 °C/s (L1), -46.9 °C/s (L2), and -12.3 °C/s (L3) — are derived from linear regression of $T_{max}(t)$ over the first 10 s post-peak (shaded windows). The non-monotonic post-peak cooling behavior is immediately apparent: L2 quenches far more rapidly than either L1 or L3, whereas L3 exhibits the slowest post-peak cooling despite recording the lowest peak temperature, consistent with progressive substrate thermal buffering across the three deposition–FSP cycles.

As shown in Figure 9 (left panel) and the $T_{max}(t)$ overlay in Figure 10, the peak surface temperature decreases monotonically with build height: 263.2 °C (L1) \rightarrow 238.9 °C (L2) \rightarrow 195.1 °C (L3). This reflects the progressive increase in the thermal conduction path to the substrate as the build height grows, combined with the elevated tool rotational speed for L2 and L3 (1200 vs. 600 rpm), which distributes frictional heat more broadly rather than concentrating it locally, while also

producing a stronger turbulent mixing action. The heating rate also increases slightly with layer number (3.00–4.10 °C/s), which is consistent with the reduced thermal mass at higher build heights.

The anomalously fast cooling of L2 may reflect a transient where the intermediate layer is sandwiched between the relatively cool substrate (L1, which had cooled to ~40 °C before L2 deposition) and the air-cooled free surface above, thereby creating an unusually strong bilateral thermal gradient. It should be noted that alternative explanations cannot be fully excluded: transient contact-conductance changes at the L1/L2 interface arising from the preceding FSP pass, or localized variations in tool-shoulder contact pressure during the L2 FSP pass, could also contribute to the anomalously rapid post-peak thermal dissipation observed for this layer; however, the bilateral gradient mechanism is the most parsimonious explanation consistent with the available IR surface data. Importantly, rather than representing a confounding anomaly, the rapid L2 quench (–46.9 °C/s) is itself corroborating evidence for the central argument: by the same mechanism proposed for L1, a faster post-peak cooling rate in L2 would be expected to favor pore closure through more rapid differential contraction, which is qualitatively consistent with the expectation of lower porosity in L2 relative to L3, even though L2 was not included in the quantitative porosity assessment. The slow cooling of L3 relative to L1, despite its substantially lower peak temperature, is attributed to the progressive accumulation of residual thermal energy in the substrate and lower build layers after three successive deposition–FSP cycles [31], which is consistent with the inter-pass heat accumulation behavior documented in multi-layer WAAM builds [31].

4. Discussion

4.1. Grain Morphology: Non-Monotonic Layer Evolution and Its Physical Basis

The earlier presented grain morphology results highlight the important role of the processing strategy and thermal environment in controlling the microstructural evolution across the build height. Three factors likely shape the non-monotonic circularity pattern, with L2 being the least equiaxed despite occupying the middle position; however, their contributions cannot be fully separated with the present dataset: (i) the thermomechanical refinement produced by each layer's own FSP pass, (ii) the partial re-elongation of already-recrystallized grains by the thermal field of the subsequent deposition step, and (iii) the layer-specific post-peak cooling rate, which controls the duration of exposure at grain-growth-permissive temperatures following FSP.

For Layer 2, the grain morphology is influenced by two distinct thermal exposures: its own FSP pass, which recrystallizes and refines the grains, and the subsequent deposition of Layer 3, which reheats the L2 material into the solid-state grain growth regime. The very rapid cooling of L2 (–46.9 °C/s) limits the time during which DRX can proceed to completion during the FSP stage, potentially leaving a greater fraction of grains in a partially recrystallized, intermediate state. The subsequent reheating from L3 deposition then coarsens these partially recovered boundaries preferentially, as they have higher stored energy and are more susceptible to boundary migration, thereby producing the lower mean circularity and equiaxed fraction observed in L2. This mechanistic interpretation is consistent with the present data but would require controlled experiments to confirm.

This combination is consistent with the bimodal grain structure (BGS) reported in Al–Cu WAAM–FSP systems [23,24], wherein a majority fine-DRX population coexists with a minority coarser-grain population produced by grain growth during the extended post-peak dwell at elevated temperature. The optical grain area distributions in Figure 3 are right-skewed but do not clearly exhibit two distinct peaks; accordingly, BGS is proposed as a consistent interpretation rather than a directly demonstrated feature of the present data. Definitive confirmation would require EBSD imaging to resolve the two grain populations crystallographically, as a mixture-model fit to a right-skewed grain area distribution from optical microscopy would be underdetermined without a priori knowledge of the modal diameters of the two populations. The result is also consistent with the continuous DRX (CDRX) pathway previously proposed for FSP-processed aluminum alloys [25,26]. $\text{Bonf} < 10^{-16}$ for both), consistent with this morphological transition representing a genuine

population-level shift in grain character rather than a sampling artifact. The result is consistent with the continuous DRX (CDRX) pathway previously proposed for FSP-processed aluminum alloys, where progressive sub grain rotation generates high-angle boundaries without a discontinuous nucleation event [25,26].

4.2. Thermal–Defect Coupling: A Cooling-Rate-Governed Consolidation Mechanism

The earlier presented thermal and defect results reveal that Layer 3 carries 80% more porosity than Layer 1, yet records a lower peak FSP surface temperature (Figures 9 and 10), which is a result at odds with the expectation that reduced thermal input eases defect formation. One confound deserves upfront acknowledgment: Layer 1 was stirred at 600 rpm, whereas Layers 2 and 3 were stirred at 1200 rpm (Table 3), so layer height and rotational speed co-vary and cannot be fully separated. To assess the directional contribution of the rpm increase quantitatively, a first-order estimate of the frictional heat input can be derived from $Q \approx (2/3)\mu F_n \omega R_s$, which represents full-contact sliding integrated over a flat circular shoulder (SI units: F_n in N, ω in rad/s, R_s in m, Q in W), where μ is the friction coefficient (~ 0.3 for Al–steel tool contact), F_n is the axial plunge force ($\sim 3,000$ – $5,000$ N for this shoulder geometry), ω is the angular velocity, and R_s is the shoulder radius (0.009 m). At 600 rpm ($\omega = 62.8$ rad/s) this yields $Q \approx 1.3$ – 2.2 kW; at 1200 rpm ($\omega = 125.7$ rad/s), $Q \approx 2.6$ – 4.4 kW. The (2/3) prefactor applies equally to both rpm levels and does not affect the directional conclusion. Doubling the frictional heat input at higher build layers would, if anything, be expected to raise the post-peak temperature and accelerate subsequent cooling through a larger thermal gradient, which is the opposite of the observed pattern, in which L3 exhibits both the lowest peak temperature and the slowest post-peak cooling rate. This directional consistency strongly supports the interpretation that progressive substrate thermal buffering, rather than the rpm increase, governs L3's anomalous thermal behavior. It should nonetheless be acknowledged that the rpm confound cannot be fully excluded as a secondary contributor, and that controlled single-variable experiments (constant rpm, varying build height) constitute the definitive test. The following mechanistic interpretation is proposed and supported by the available evidence, with the caveat that direct subsurface temperature and pressure measurements were not performed in this study.

In the context of void consolidation, the closure during FSP is driven mainly by the plastic flow of matrix material into pore interiors under the hydrostatic pressure and shear stress generated by the rotating shoulder and pin. This mechanism operates while the material remains within the solid-state deformation window, estimated at roughly 300–450 °C for Al 4043 based on published FSP literature for this alloy system. It should be noted that the IR surface temperatures reported here (peak values of 195–263 °C) are substantially lower than this deformation window, which represents a primary instrumentation limitation of the present study; as noted in Section 2.4, surface thermography cannot directly measure stir-zone temperatures. This apparent contradiction is resolved by the well-established disparity between surface-measured and subsurface stir-zone temperatures in FSP: the rotating tool generates intense frictional and plastic dissipation heat locally within the stir zone, where temperatures typically reach 0.6–0.9 T_{solidus} and are expected to lie within the 300–450 °C deformation window, while the IR camera captures only the cooler workpiece surface remote from the tool–material interface. This surface–subsurface temperature disparity has been directly documented in FSW and FSP of aluminum alloys through embedded thermocouple and thermocouple-pin measurements: Tang et al. [32] reported stir-zone temperatures 150–250 °C above surface measurements in FSW of 6061-T6 aluminum, and Gerlich et al. [33] confirmed analogous through-thickness temperature gradients in friction stir spot welding of aluminum alloys, with peak stir-zone temperatures substantially exceeding surface IR readings in both cases. It should be noted that the internal stir-zone temperatures were not directly measured in this study, as described in Section 2.4. Once the tool has passed, further closure can still occur as the workpiece contracts on cooling, provided that the contraction rate outruns stress relaxation. For L1 at -16.2 °C/s, that condition is met and differential contraction assists the final pore closure. A similar behavior has been noted in FSP of aluminum castings, where faster post-tool cooling correlates with lower residual

porosity [12]. For L3 at -12.3 °C/s, the situation is less favorable: extended time at elevated temperature promotes stress relaxation, thereby weakening the consolidation driving force, and may also allow thermally activated void growth at particle–matrix interfaces, though this interpretation remains speculative without direct compositional mapping.

The SEM evidence at $12,000\times$ – $20,000\times$ provides direct morphological support for this interpretation. The consistent spatial co-location of sub-micron pores with fragmented second-phase particles in Layer 2 suggests preferential void persistence or nucleation near particle–matrix interfaces. It should be noted that EDS or EBSD mapping was not performed in this study, which prevents direct confirmation of particle phase identity and compositional gradients near pore–particle interfaces. It should be noted that this represents a recognized experimental limitation that constrains the pore–particle co-location finding to morphological evidence; the mechanistic interpretation of preferential void persistence near particle–matrix interfaces therefore remains hypothesis-level until supported by compositional characterization. EDS/EBSD mapping is identified as the single highest-priority future experiment for this work.

The spatial heterogeneity of porosity within L3, wherein position P2 (right edge) exhibited 3.82% versus 1.57% at position P3 (left edge), is also consistent with this mechanism. One possible contributor is a lateral gradient in tool shoulder pressure across the bead width, though it should be noted that the tool deflection and local pressure distribution were not directly measured in this study, and this interpretation therefore remains tentative. This position-dependence underscores the importance of achieving tool pressure uniformity for consistent defect mitigation in multi-pass multi-layer UAMFSP builds.

Earlier studies on FSP-assisted WAAM reported related trends; the present data add a layer-resolved thermal explanation that advances the mechanistic understanding. Sun et al. [27] demonstrated that interlayer FSP in WAAM 2319 Al eliminates macroscopic porosity while redistributing Al_2Cu precipitates, improving tensile strength and ductility; the present work indicates that macro-closure does not preclude micro-porosity persistence under unfavorable thermal conditions. Also, Zhou et al. [28] reported substantial strength gains ($\sim 30\%$) in Al–Cu–Sc WAAM+FSP walls; the results of the present study indicate that these improvements may be partially offset by increased upper-layer porosity if the interlayer cooling dynamics are not optimized.

4.3. Implications for Process Optimization

The earlier presented thermal–defect results provide a first mechanistic framework for understanding how post-peak cooling rate governs porosity evolution in multi-layer UAMFSP builds, with practical implications for process design. Based on the data, the explicit management of the post-peak cooling rate, rather than peak temperature alone, is identified as the primary requirement for achieving void consolidation quality in multi-layer UAMFSP builds. Several engineering strategies follow from this analysis.

First, active cooling immediately after tool retraction (within the critical first 10 s post-peak window captured by IR thermography in this study), for example through compressed air or forced convection, would increase the post-peak cooling rate in the upper layers and bring the L3 conditions closer to the more favorable L1 thermal environment. This active post-FSP cooling is distinct from the existing inter-pass cooling protocol (38 – 40 °C baseline before restarting deposition) and would operate on a much shorter timescale, targeting the immediate post-tool dwell period rather than the bulk inter-layer cooldown. Second, substrate pre-cooling before the upper-layer deposition step could reduce the thermal buffering effect by restoring a stronger conduction gradient. Third, tool parameter optimization for the upper layers, specifically employing a higher traverse speed or reduced rotational speed for L3, could shorten the post-peak dwell at elevated temperature; however, a more nuanced layer-specific optimization scheme that independently controls heat input and stirring intensity is warranted.

Several directions would strengthen this work and are recommended for future investigations. Thermocouple or embedded-sensor measurements inside the stir zone would decouple the surface

and subsurface thermal histories, thereby directly addressing the key temperature measurement limitation of the present study. EDS and EBSD mapping of the stir zone would simultaneously confirm particle phase identity, provide direct evidence of compositional gradients near pore-particle interfaces, and supply crystallographic texture data and grain orientation mapping to complement the optical circularity analysis presented here. Extended builds of five or more layers would clarify whether the porosity gradient continues to grow or reaches a steady state, and tensile and fatigue testing are needed to quantify the mechanical consequences of the 80% porosity increase in L3. Furthermore, residual stress measurements by X-ray or neutron diffraction would characterize the net stress state following SPD redistribution. Also, a controlled constant-parameter experimental study is currently underway to isolate the thermal contribution independently of the rotational speed variation, which is expected to provide definitive evidence for or against the cooling-rate hypothesis proposed here.

5. Conclusions

In this study, multi-layer Al 4043 walls fabricated by UAMFSP were examined across their thermal, microstructural, and defect characteristics, employing IR thermography, optical grain morphology analysis, multi-scale SEM, and calibrated porosity quantification. The results are presented as a first mechanistic framework identifying post-peak cooling rate as a governing parameter for porosity evolution in hybrid WAAM-FSP builds. Six principal findings emerge from this investigation.

1. The UAMFSP process produces highly refined microstructures across all three build layers, with the mean equivalent grain diameter confirmed to be below $3.4\ \mu\text{m}$ in every layer, thereby confirming effective DRX-driven grain refinement throughout the full build height. This remarkable degree of refinement is consistent with the well-established role of the FSP in promoting severe plastic deformation and dynamic recrystallization in aluminum alloys.
2. Grain morphology evolves non-monotonically with build height: Layer 2 displays the lowest mean circularity (0.569) and equiaxed fraction (25.5%), while Layer 3 achieves the highest values (0.645 and 36.1%). One-way ANOVA ($F = 56.2$, $p = 5.15 \times 10^{-25}$) and Kruskal-Wallis ($H = 121.3$, $p = 4.69 \times 10^{-27}$) confirm that these inter-layer differences are statistically significant. The non-monotonic pattern is attributed to layer-specific FSP thermomechanical conditions, differential reheating from subsequent deposition, and layer-resolved post-peak cooling rates, with the mechanistic interpretation requiring future controlled experiments to fully decouple these contributions.
3. Multi-scale SEM imaging ($250\times$ – $35,000\times$) resolved the second-phase particle landscape of UAMFSP-processed Al 4043: the Al-Si eutectic fragments exhibited a range of morphologies from elongated laths ($AR \approx 3$ – 8) to partially spheroidized compact particles, reflecting incomplete spheroidization under single-pass FSP conditions. Also, sub-micron gas/shrinkage-type pores are consistently spatially co-located with second-phase particles, providing morphological evidence consistent with preferential void persistence near particle-matrix interfaces; confirmation via EDS/EBSD compositional mapping is recommended as a priority for future work.
4. The porosity area fraction was found to increase substantially from L1 ($1.61 \pm 0.75\%$) to L3 ($2.90 \pm 1.18\%$), representing an 80% increase, alongside a 107% increase in pore density ($2,068$ to $4,283$ pores/ mm^2). It should be noted that this trend is counterintuitive given that L3 records a 26% lower peak FSP surface temperature than L1, which further underscores the importance of post-peak cooling rate as the governing thermal metric for void consolidation quality.
5. The apparent contradiction is resolved by the post-peak cooling rate: L3 cools at only $-12.3\ \text{°C/s}$ versus $-16.2\ \text{°C/s}$ for L1, despite the lower peak temperature. The slower cooling of L3 reflects the cumulative substrate thermal buffering after three successive deposition-FSP cycles, which reduces the temperature gradient available for conduction cooling. This extended post-peak dwell at elevated temperature impairs void closure, confirming that the post-peak cooling rate,

rather than peak temperature, is a more informative thermal metric for defect consolidation quality in the present build configuration, thereby establishing this relationship as a testable hypothesis for future controlled investigation. Future work employing controlled single-variable experiments is needed to fully decouple these effects and elevate the present correlation to a causal mechanistic relationship.

6. The primary technological implication of this first mechanistic framework is that post-peak cooling rate warrants explicit management on a layer-by-layer basis in UAMFSP multi-layer builds. Active post-FSP cooling, substrate pre-cooling, or layer-specific traverse speed optimization represent practical engineering pathways that can be employed to reduce upper-layer porosity while maintaining the grain refinement benefits established at lower layers. More broadly, the finding that the post-peak cooling rate governs defect consolidation quality is expected to be relevant to similar hybrid AM systems in which interlayer heat accumulation progressively modifies the solid-state post-processing thermal environment, suggesting that the present findings may have value beyond the specific UAMFSP configuration examined here; however, direct validation in other hybrid AM systems is needed before broader generalization.

Supplementary Materials: The following supporting information can be downloaded at the website of this paper posted on Preprints.org.

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Abbreviations

The following abbreviations are used in this manuscript:

ANOVA	Analysis of Variance
AR	Aspect Ratio Proxy
BGS	Bimodal Grain Structure
CDRX	Continuous Dynamic Recrystallization
CI	Confidence Interval
DED	Directed Energy Deposition
DRX	Dynamic Recrystallization
EBSD	Electron Backscatter Diffraction
EDS	Energy-Dispersive X-ray Spectroscopy
ER4043	Al-Si welding wire/filler alloy (AWS designation)
FSP	Friction Stir Processing
FSW	Friction Stir Welding
HV	Vickers Hardness
IR	Infrared

KDE	Kernel Density Estimate
MIG	Metal Inert Gas
PAW	Plasma Arc Welding
ROI	Region of Interest
SEI	Secondary Electron Imaging
SEM	Scanning Electron Microscopy
SPD	Severe Plastic Deformation
TIG	Tungsten Inert Gas
UAMFSP	Unified Additive–Deformation Manufacturing Process
WAAM	Wire Arc Additive Manufacturing

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